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## ULTRA FAST RECOVERY RECTIFIER DIODES



Glass-passivated, high-efficiency epitaxial rectifier diodes in DO-4 metal envelopes, featuring low forward voltage drop, ultra fast reverse recovery times, very low stored charge and soft recovery characteristic. They are intended for use in switched-mode power supplies and high-frequency circuits in general, where low conduction and switching losses are essential. The series consists of normal polarity (cathode to stud) types.

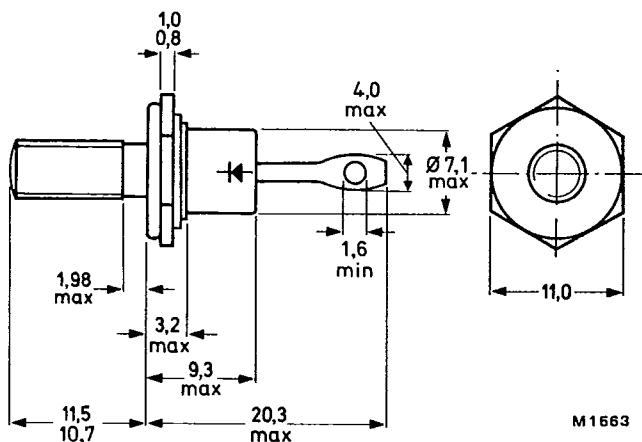
## QUICK REFERENCE DATA

		BYW30-50	100	150	200	
Repetitive peak reverse voltage	V <sub>RRM</sub>	max. 50	100	150	200	V
Average forward current	I <sub>F(AV)</sub>	max.		14		A
Forward voltage	V <sub>F</sub>	<		0.8		V
Reverse recovery time	t <sub>rr</sub>	<		30		ns

## MECHANICAL DATA

Dimensions in mm

Fig.1 DO-4: with metric M5 stud ( $\phi$ 5 mm); e.g. BYW30-50.  
with 10-32 UNF stud ( $\phi$ 4.83 mm); e.g. BYW30-50U.



M1663

Net mass: 6 g

Diameter of clearance hole: max. 5.2 mm

Accessories supplied on request:  
see ACCESSORIES section.

Supplied with device: 1 nut, 1 lock washer

Torque on nut: min. 0.9 Nm (9 kg cm)  
max. 1.7 Nm (17 kg cm)

Nut dimensions across the flats:  
M5: 8.0 mm; 10-32 UNF: 9.5 mm.



Products approved to CECC 50 009-001, available on request.

**RATINGS**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Voltages*		BYW30-50	100	150	200	
Repetitive peak reverse voltage	$V_{RRM}$	max.	50	100	150	200 V
Crest working reverse voltage	$V_{RWM}$	max.	50	100	150	200 V
Continuous reverse voltage	$V_R$	max.	50	100	150	200 V

**Currents**

Average forward current; switching

losses negligible up to 500 kHz

square wave;  $\delta = 0.5$ ; up to  $T_{mb} = 120^{\circ}\text{C}$   
up to  $T_{mb} = 125^{\circ}\text{C}$ sinusoidal; up to  $T_{mb} = 125^{\circ}\text{C}$ 

R.M.S. forward current

Repetitive peak forward current  
 $t_p = 20 \mu\text{s}; \delta = 0.02$ Non-repetitive peak forward current  
half sine-wave;  $T_j = 150^{\circ}\text{C}$  prior to surge;  
with reapply  $V_{RWMmax}$ : $t = 10 \text{ ms}$  $t = 8.3 \text{ ms}$  $I^2t$  for fusing ( $t = 10 \text{ ms}$ )

$I_{F(AV)}$	max.	14	A
$I_{F(AV)}$	max.	12	A
$I_{F(AV)}$	max.	12.5	A
$I_{F(RMS)}$	max.	20	A
$I_{FRM}$	max.	420	A
$I_{FSM}$	max.	200	A
$I_{FSM}$	max.	240	A
$I^2t$	max.	200	$\text{A}^2\text{s}$

**Temperatures**

Storage temperature

 $T_{stg}$  -55 to +150  $^{\circ}\text{C}$ 

Junction temperature

 $T_j$  max. 150  $^{\circ}\text{C}$ **THERMAL RESISTANCE**

From junction to mounting base

 $R_{th j-mb}$  = 2.2 K/W

From mounting base to heatsink

a. with heatsink compound

 $R_{th mb-h}$  = 0.5 K/W

b. without heatsink compound

 $R_{th mb-h}$  = 0.6 K/WTransient thermal impedance;  $t = 1 \text{ ms}$  $Z_{th j-mb}$  = 0.3 K/W**MOUNTING INSTRUCTIONS**

The top connector should be neither bent nor twisted; it should be soldered into the circuit so that there is no strain on it.

During soldering the heat conduction to the junction should be kept to a minimum.

\*To ensure thermal stability:  $R_{th j-a} \leq 5.6 \text{ K/W}$  (continuous reverse voltage).

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**CHARACTERISTICS**

Forward voltage

$I_F = 15 \text{ A}; T_j = 150^\circ\text{C}$   
 $I_F = 50 \text{ A}; T_j = 25^\circ\text{C}$

$V_F$	<	0.8	$V^*$
$V_F$	<	1.3	$V^*$

Reverse current

$V_R = V_{RWM} \text{ max}; T_j = 100^\circ\text{C}$   
 $T_j = 25^\circ\text{C}$

$I_R$	<	1.3	mA
$I_R$	<	25	$\mu\text{A}$

Reverse recovery when switched from

$I_F = 1 \text{ A}$  to  $V_R \geq 30 \text{ V}$  with  $-dI_F/dt = 100 \text{ A}/\mu\text{s}$ ;

$t_{rr}$	<	30	ns
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$T_j = 25^\circ\text{C}$ ; recovery time

$I_F = 2 \text{ A}$  to  $V_R \geq 30 \text{ V}$  with  $-dI_F/dt = 20 \text{ A}/\mu\text{s}$ ;

$Q_s$	<	15	nC
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$T_j = 25^\circ\text{C}$ ; recovered charge

$I_F = 10 \text{ A}$  to  $V_R \geq 30 \text{ V}$  with  $-dI_F/dt = 50 \text{ A}/\mu\text{s}$ ;

$I_{RRM}$	<	4	A
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$T_j = 100^\circ\text{C}$ ; peak recovery current

Forward recovery when switched to  $I_F = 10 \text{ A}$

with  $dI_F/dt = 10 \text{ A}/\mu\text{s}$ ;  $T_j = 25^\circ\text{C}$

$V_{fr}$	typ.	1.0	V
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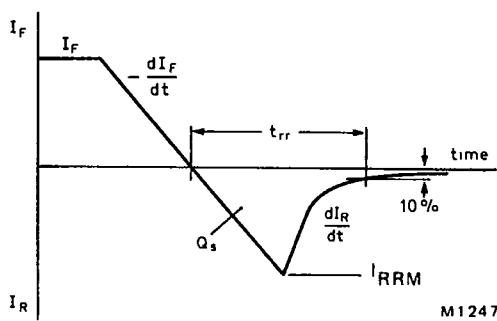


Fig.2 Definition of  $t_{rr}$ ,  $Q_s$  and  $I_{RRM}$ .

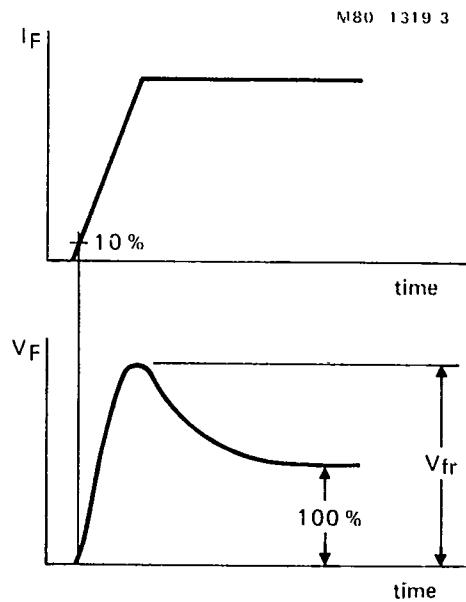


Fig.3 Definition of  $V_{fr}$ .

\* Measured under pulse conditions to avoid excessive dissipation.

## SQUARE-WAVE OPERATION

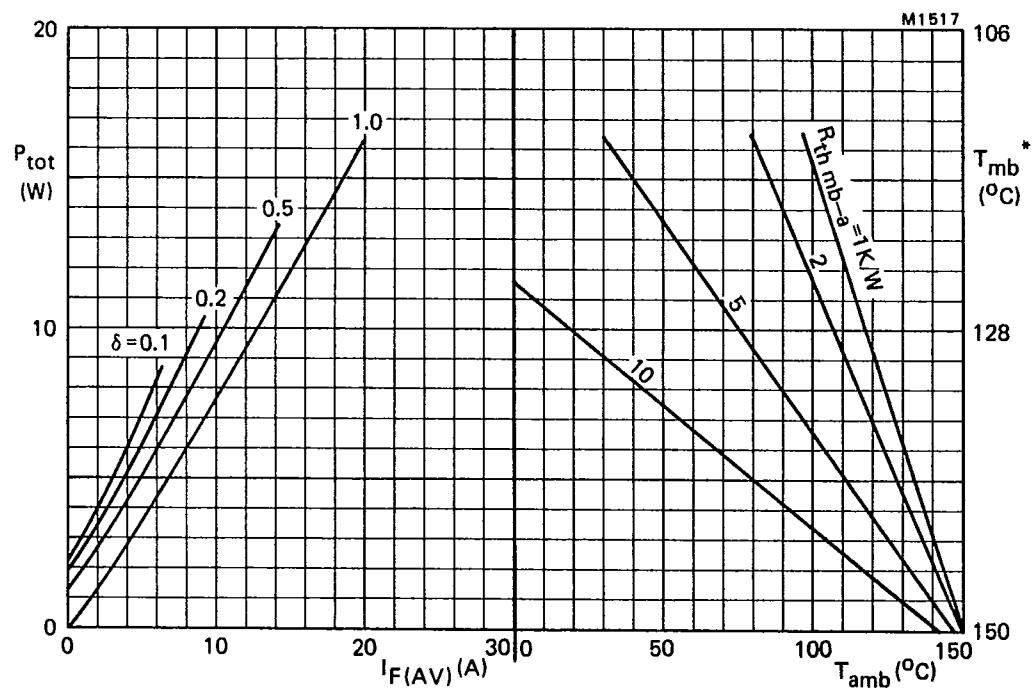
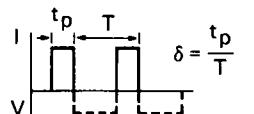


Fig.4 The right-hand part shows the interrelationship between the power (derived from the left-hand part) and the maximum permissible temperatures. Power includes reverse current losses and switching losses up to  $f = 500$  kHz.



$$I_F(AV) = I_F(\text{RMS}) \times \sqrt{\delta}$$

\* $T_{mb}$  scale is for comparison purposes and is correct only for  $R_{th\ mb-a} < 3.1\text{ K/W}$ .

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## SINUSOIDAL OPERATION

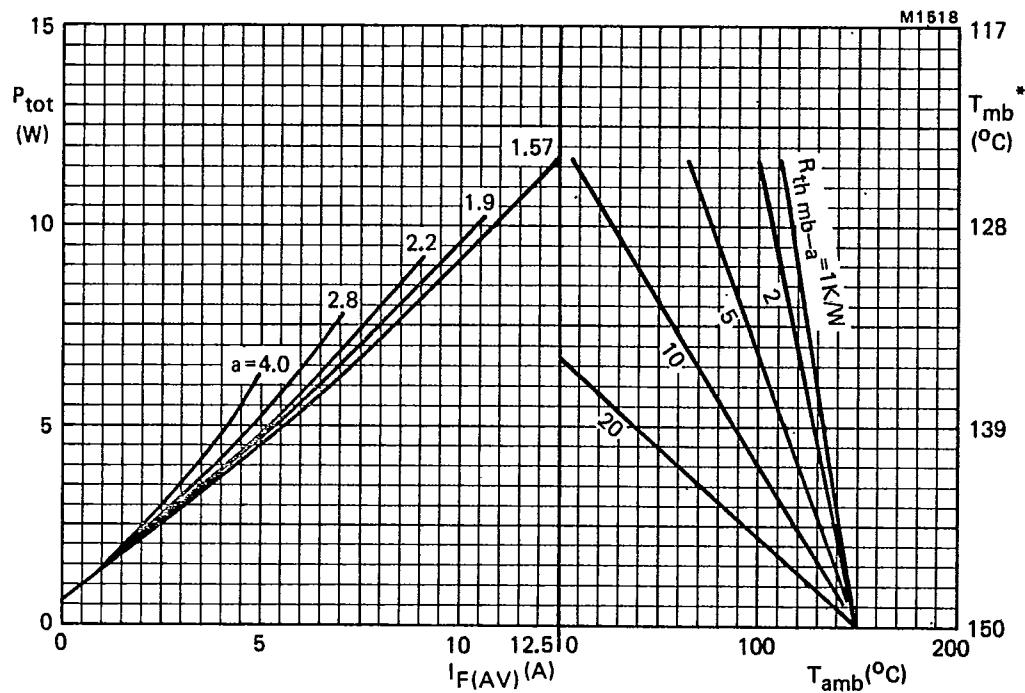


Fig.5 The right-hand part shows the interrelationship between the power (derived from the left-hand part) and the maximum permissible temperatures.

$$a = \text{form factor} = I_F(\text{RMS})/I_F(\text{AV}).$$

\* $T_{mb}$  scale is for comparison purposes and is correct only for  $R_{th mb-a} < 17 \text{ K/W}$ .

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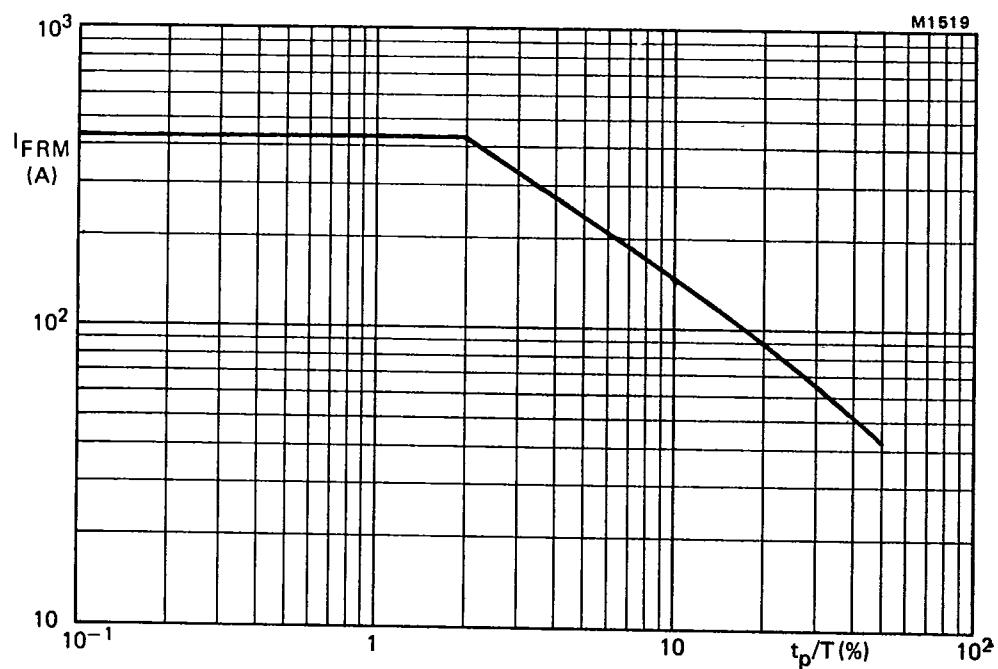
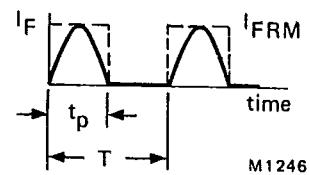
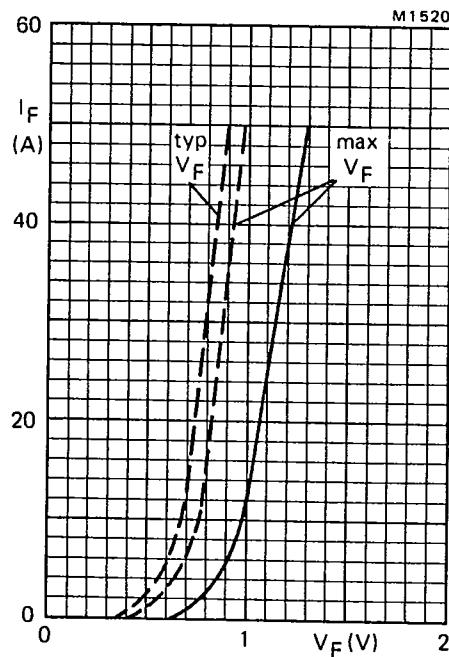


Fig.6 Maximum permissible repetitive peak forward current for square or sinusoidal currents;  
 $\mu s < t_p < 1$  ms.



Definition of  $I_{FRM}$   
and  $t_p/T$ .

Fig.7 ——  $T_j = 25^\circ C$ ; - - -  $T_j = 150^\circ C$ .

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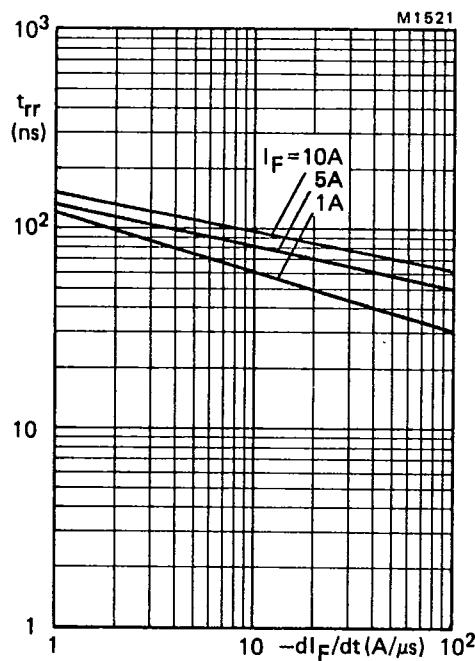


Fig.8 Maximum  $t_{rr}$  at  $T_j = 25$  °C.

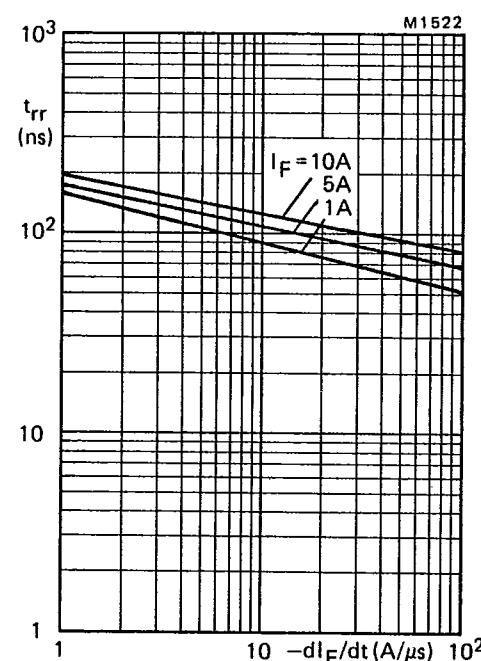


Fig.9 Maximum  $t_{rr}$  at  $T_j = 100$  °C.

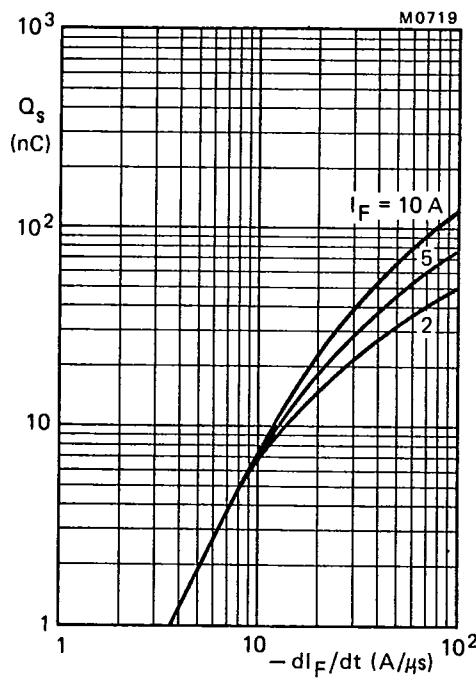


Fig.10 Maximum  $Q_s$  at  $T_j = 25$  °C.

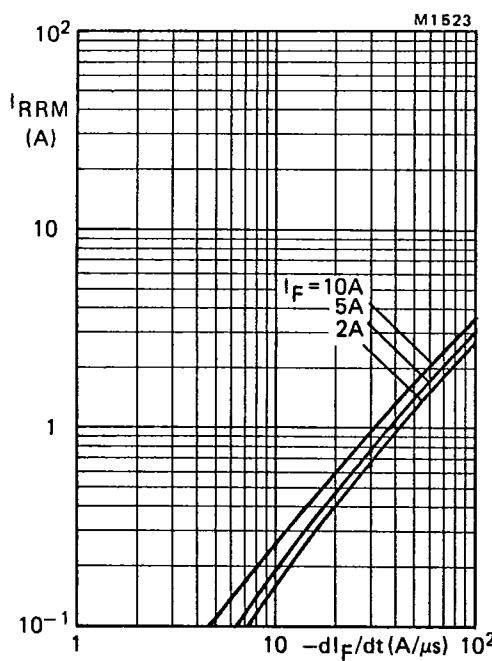
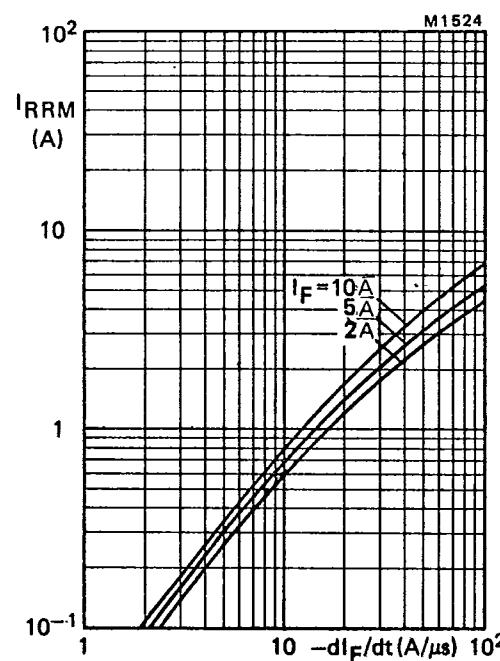
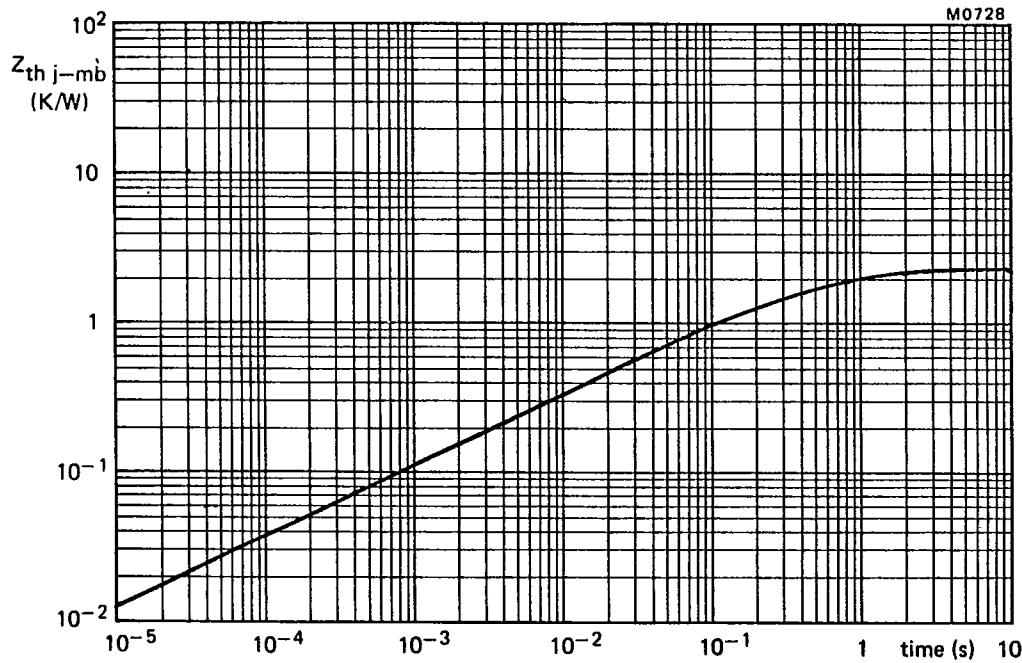
Fig.11 Maximum  $I_{RRM}$  at  $T_j = 25$  °C.Fig.12 Maximum  $I_{RRM}$  at  $T_j = 100$  °C.

Fig.13 Transient thermal impedance.